

Wet Etching Agent for Semiconductors Hydrofluoric Acid HF49%, HF50%

TECHNICAL
DATASHEET

The wet etching agent Hydrofluoric Acid (HF) is a high-quality etching agent in which the level of impurities, such as metal ions, have been greatly decreased for use in semiconductor manufacturing.

General physical properties

Items	Unit	Numeric Value
HF Concentration	mass%	(HF49%)49 (HF50%)50

Inspection Items

- Anionic impurities(Cl, NO₃, PO₄, SO₄)
- Metal impurities(Fe, Na, K, etc., more than 20 metals)
- Particles

Please contact us for details on the quality levels of individual items.

Handling method/Safety information

- Be sure to read the notes on SDS and labels before use.
- This product has been developed for industrial purposes and we shall not guarantee the safety if used for any other purposes. If it is going to be used for medical or food applications, please contact us in advance.

Packing specification

- 22.5L bottle, 200L drum, ISO container

For more information, visit our website.

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tds-hf-4950-E_ver01_Aug_2019
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